



W. W. Hansen Experimental Physics Laboratory

STANFORD UNIVERSITY STANFORD, CALIFORNIA 94305 - 4085

Gravity Probe B Relativity Mission

Detector Package Assembly Test Readiness Review Completion Certificate

GP-B P0261

February 6, 1998

_Signed _____

Prepared by: Sei Chun Systems Engineer

Approved by: John Goebel Telescope Readout Electronics Responsible Engineer

Approved by: Paul EhrensbergerDateTelescope Readout Electronics Integrated Product Team Leader

Approved by: B. Taller Quality Assurance

Approved by: Bob Schultz Chief Systems Engineer

Approved by: J. Turneaure Hardware Manager _3/27/98____ Date

Date

Date

Date

Date

Detector Package Assembly Test Readiness Review

Date & Time: February 6, 1998, 8:00 to 9:30 A.M. Location: GP-B conference room

Purpose:

To ensure that the test article hardware, test facility, ground support personnel, and test procedures are ready for testing, data acquisition, reduction, evaluation, and control.

Scope:

The Detector Package Assembly Test Readiness Review (TRR) will encompass all Detector Package Assembly (DPA) flight hardware. The DPA flight hardware includes the completed Detector Package Assemblies and their components.

Agenda:

- Requirements Traceability Status
- Procedure Status
- Test Personnel Status
- Test Resources Status
- Test Support Software Status

Review Team:

John Turneaure	Hardware Manager
Paul Ehrensberger	DPA Product Team Lead
John Goebel	DPA Test Lead
Bob Farley	Engineer
Ben Taller	Quality Assurance
Bob Schultz	Chief Systems Engineer
Sei Chun	Systems Engineer
Ed Ingraham	ONR (ex officio)

Objectives:

- Confirm that in-place test plans and procedures meet verification requirements and specifications.
- Confirm that sufficient and detailed resources (of the right type) are allocated to the test effort.
- Examine detailed test procedures for completeness and safety during test operations. Note who is in charge of the test operations and test article and who is in charge of the facilities.
- Determine the critical test personnel who are authorized to perform test.
- Confirm that test support software is adequate, pertinent, and verified (validated for intended use).
- Confirm that all interfaces with the test article, test equipment, and facilities, especially power, data, instrumentation, etc., are adequate, safe, and in accordance with the test procedure. Ensure the customer, witnessing agents, test personnel, quality assurance, and support personnel understand the objective of the test and the parameters that are critical for successful operation.
- Confirm that the documentation has proper traceability.
- Confirm that test equipment has been appropriately calibrated.

TRR Exit Criteria:

The following items identify the categories of items to be checked; the individual checks are enumerated in the attached checklists:

- Do the test procedures verify all applicable requirements?
- Have the test procedures been "dry-runned"? Do they indicate satisfactory operation?
- Have test personnel received training in test operations procedures?
- Are resources available to adequately support the planned tests as well as contingencies, including failed hardware replacement?
- Has the test support software been demonstrated to handle test configuration assignments, and data acquisition, reduction, evaluation, control, and archiving?

Attachments:

- A. Manufacturing and Test Flow diagram
- B. Requirements Verification Matrix
- C. Document Status Checklist
- D. Test Personnel Status Checklist
- E. Test Resources Checklists and Test Support Software Checklist
- F. Action Items Closure List

A. DPA Manufacturing and Test Flow Diagram



A-1

P0261 2/6/98

P0261 2/6/98

Test



B. Detector Package Assembly Verification Matrix

Telescope Readout Electronics Specification PLSE-13 Part #3

Paragraph	Title	Text & Comments	Method	Verification Plan	✓
3.2.5	Telescope Detector Mount Assembly	See attached Doc. Text File for an overview of this section.			
3.2.5.1	Vibration Environment	Protoqual @ LN ₂ 77K	S,T	P0358 DMA vibration test procedure S-Doc TBS	
3.2.5.2	Detector Package				
	Alignment				
3.2.5.2.1	Pitch/Roll	<= 10 arcmin	Ι	Inspect vendor data	
	Yaw	<=30 arcmin			
3.2.5.2.2	Defocus	<=500 μm	Ι	Inspect vendor data	
3.2.5.2.3	Decenter	<=500 µm	Т	P0392: Thermal Alignment and Decenter Test	
3.2.5.3	Platform Temperature Variation at Roll Frequency, as defined in T003, 7.6.2	<= 2 mK	A,T	Payload level verification	
3.2.5.4	Deleted				
3.2.5.5	Electrical Lead Resistance	<= 100 ohms	Т	P151- Detector Mount Subassembly Build	
3.2.5.6	Base Temperature				
3.2.5.6.1	Base Operational	2-6 K	N/A		
	Temperature				
3.2.5.6.2	Base Test Temperature	2 - 290 K	N/A		
3.2.5.6.3	Base Bakeout Temperature (survive)	340 K	Т	P0151	
3.2.5.7	Deleted				
3.2.6	Detector Thermal Output				
3.2.6.1	Total Telescope Detector Power (All Detectors)	<=6 mW (1.5 mW/platform)	Т	P392: Power Dissipation Test	
3.2.7	Detector Base Operational				
	Temperature Range				
3.2.7.1	Operational Temperature	6K - 2K	N/A		
	range at 10 fA, 10 pA, and			Header	
	1 microAmp Photo				
	Current Levels				
3.2.7.2	Operational Temperature	300K - 2.0 K	N/A		
	Range at 10 pA Current			Header	
	Level				

				2/	6/98
3.2.13	Telescope to Telescope Detector Interface	Large Picture available in Doc. Text File. Assuming: 65-50% Strehl ratio 0.4 - 1.0 micron wavelength >=70% photons shall fall on the detector 53-21% transmission efficiency -/+ 60 arcsec ST field of view Worst case Guide Star (V711 TAURI) 80% photodetector efficiency Expected photo-current = 12 fA per detector when telescope is centered Scale Factor≥ 18*10^(-18) Amp/marcsec per detector			
3.2.18	TRE Detector Performance Requirement				
3.2.18.1	External Quantum Efficiency at 400 to 900 nm wavelength	>70%	S,A,T	P0392: Optical Responsivity test one fight unit will be tested over several wavelength and use similarity for other flight units. S-Doc TBS	
3.2.18.2	External Quantum Efficiency at 550nm wavelength	>70 %	Т	P0392: Optical Responsivity test	
3.2.18.3	I_Dark	<0.01 fA@ 80 K	Т	P0392: Electrical Leakage Current Test Measure w/o light and at V_detB=4.0V @ 80 K	
3.2.18.4	Diameter of Photoactive Area	0.8 mm	Ι	P332	
3.2.18.5	Deleted				
3.2.18.6	Operating Temperature (Si JFETs)	80 K±10 K	Т	P0392 : Temperature Stability Test Measure without light and at V_detB=4.0V @80 K with all components	
3.2.18.7	Random Noise	<50 e rms/(0.1 sec read)	Т	P0392: Noise test	
3.2.18.8	Temperature Stability	<440 e/(read)/K	Т	P0392: Thermal Coefficient Stability Test	

P0261

C. Detector Package Assembly Requirements Verification Documents Checklist

	0								
Document	Revision	Author	Title	Written	In	Approval	Dwg	Flow	Verif
	Date				Database	Status	Ref	Ref	Ref
P0151	11/26/97	P.Ehrensberger	Procedure for Detector Package Assembly Fabrication	\checkmark	\checkmark	Approved	\checkmark	\checkmark	\checkmark
P0219	11/22/97	P.Ehrensberger	Telescope Detector Circuit Assembly Fabrication	✓	N/A	Approved	N/A	\checkmark	N/A
P0332	11/18/97	H. Dermroff	Incoming Inspection and test procedure for FLT Rev D	\checkmark	\checkmark	Approved	N/A	\checkmark	\checkmark
			TRE circuit on Sapphire carrier						

Detector Package Fabrication & Assembly

Detector Package Test

Document	Revision	Author	Title	Written	In	Approval	Dwg	Flow	Verif
	Date				Database	Status	Ref	Ref	Ref
P0392	2/12/98	J. Goebel	Detector Package Assembly (DPA) Acceptance Test Procedure	~	✓	Approved	N/A	N/A	~
P0358	4/3/98	J. Goebel	Telescope Detector Mount Assembly Vibration testing	\checkmark		In-Review	N/A	N/A	\checkmark

Additional Documents

Document	Date	Author	Title	Written	In	Approval	Dwg
					Database	Status	Ref
P0057 A	9/29/94	J. Lockhart	GP-B Magnetic Control Plan - Science Mission	✓	\checkmark	Approved	\checkmark
P0059 C	6/19/94	M. Keiser	GP-B Contamination Control Plan (Probe B)	\checkmark	\checkmark	In-Review	\checkmark
P0080	8/1/92	J. Lockhart	Cryogenic Magnetic Screening Procedure	\checkmark	\checkmark	Approved	\checkmark
P0357	2/10/98	H. Demroff	Procedure for DPA Electrostatic Discharge Precaution	\checkmark	\checkmark	Approved	N/A
23200-119 D	3/5/98	B. Taller	DRAWING TREE, DETECTOR PACKAGE KIT, SM	\checkmark	\checkmark	Approved	\checkmark
25712-103	11/27/97	M. Sullivan	DETECTOR PACKAGE KIT, CHANNEL A	\checkmark	\checkmark	Approved	\checkmark
25712-104	11/27/97	M. Sullivan	DETECTOR PACKAGE KIT, CHANNEL B	\checkmark	\checkmark	Approved	\checkmark

D. Detector Package Assembly Test Personnel Status Checklist

Test Conductor / QA

The test conductor is John Goebel The QA personnel are Ben Taller and Phil Unterreiner

Test Director

Paul Ehrensberger

Procedures Requiring Director Approval

#	Title
P0392	Detector Package Assembly (DPA) Acceptance Test Procedure
P0358	Telescope Detector Mount Assembly Vibration Test Procedure

E. Detector Package Assembly Test Resources Checklists

Instruments Requiring Calibration

Item Description	ID / Serial Number	Calibration	Available
		Date	
NIST 100W tungsten filament lamp	EPIR-1086	1984	✓
NIST Silicon Photodiode	D213	9/30/97	~
Tek 744A Oscilloscope	B041929	2/09/98	~
Tek 420A Oscilloscope	B051297	2/09/98	~
Tek 540A Oscilloscope	B011828	2/25/98	\checkmark
Silicon Diode Thermometers	BC557T	7/96	~
HP3458A Multimeter	2823A16067	2/10/98	\checkmark
Germanium Temperature Sensor	N/A	N/A	✓
LakeShore DRC93CA Controller	17483	2/11/98	✓

Non-standard Test Equipment

Electrical Ground Support Equipment		\checkmark

Facilities

Test Support Software

Software Product	Version	Controlled	Demonstrated
Engineering Test Unit Software (Optical Response.vi, Noise.vi,	1.0	\checkmark	✓
Leakcurrent.vi, ThermalTest.vi)			
Lab View data acquisition software	4.1	\checkmark	\checkmark
Mathcad	3.1	\checkmark	 ✓
SQUID	3.4	\checkmark	\checkmark
GPIB Driver NI-488	7.1.3	\checkmark	\checkmark
KaleidaGraph	3.0.4	\checkmark	 ✓

F. Action Item Closure Status

#	DPA status meeting Action Items (1/30/98)	Assignee	ECD	Status
1	Get vibration environment from Gayload, Ken Shaul	Ehrensberger	2/2/98	Open
2	Clarify Defocus and Decenter requirement (PLSE-13 Pt 3 Para	Chun &	2/2/98	Closed
	3.2.5.2.2 & 3.2.5.2.3	Sullivan		
3	Verify proposed deletions are covered in the higher level	Chun	2/5/98	Closed
	(3.2.5.5 to 3.2.5.6.3)			
4	Update P0392 to include thermal test to verify 3.2.6.1	Goebel	2/5/98	Closed
5	Update P0392 to test quantum efficiency (3.2.18.1) on one	Goebel	2/5/98	Closed
	flight unit over several wavelength and use similarity to verify			
	other flight units (all flight units tested at 550nm for 3.2.18.2)			
6	Complete ECO for 23200-119B drawing tree, Detector Pkg	Turneuare	2/5/98	Closed
	Kit, SM			
7	Add to P0151 step to have each completed DPA magnetically	Ehrensberger	2/5/98	Closed
	screened			~
8	Identify and train additional personnel to witness testing	Taller	2/17/98	Closed
9	Collect Cal data	Goebel	2/17/98	Closed
10	Complete Test support SW list and special backup for	Chun/Coleman	2/17/98	Closed
	configuration control			
11	Paviaw additional documents needed for TPP nackage	Ehronchorger	0/ <i>E</i> /00	
11	Keview additional documents needed for TKK package	Enrensberger	2/5/98	Closed
11	Prepare PCB package for DPA requirement and verification	Chun	2/5/98	Closed
11	Prepare PCB package for DPA requirement and verification change	Chun	2/5/98	Closed
11 12 #	Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98)	Chun Assignee	2/5/98 2/5/98 ECD	Closed Closed Status
11 12 # 1	Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e.	Ehrensberger Chun Assignee Ehrensberger	2/5/98 2/5/98 ECD 2/25/98	Closed Closed Status Closed
11 12 # 1	Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple	Ehrensberger Chun Assignee Ehrensberger	2/5/98 2/5/98 ECD 2/25/98	Closed Closed Closed Closed
11 12 # 1	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc.	Ehrensberger Chun Assignee Ehrensberger	2/5/98 2/5/98 ECD 2/25/98	Closed Closed Closed Closed
11 12 # 1 2	Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and	Ehrensberger Chun Assignee Ehrensberger Ehrensberger	2/5/98 2/5/98 ECD 2/25/98 7/31/98	Closed Closed Closed Closed Open
11 12 # 1 2	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing	Ehrensberger Assignee Ehrensberger Ehrensberger	2/5/98 2/5/98 ECD 2/25/98 7/31/98	Closed Closed Closed Closed Open
11 12 # 1 2 3	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the	Ehrensberger Chun Assignee Ehrensberger Ehrensberger Goebel	2/5/98 2/5/98 2/25/98 7/31/98 2/25/98	Closed Closed Closed Closed Open Closed
11 12 # 1 2 3	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K)	Ehrensberger Chun Assignee Ehrensberger Ehrensberger Goebel	2/5/98 2/5/98 2/25/98 7/31/98 2/25/98	Closed Closed Closed Closed Closed Closed
11 12 # 1 2 3 4	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K) Consider making all test at three different temperatures (70 K,	Ehrensberger Chun Assignee Ehrensberger Goebel Goebel	2/5/98 2/5/98 2/25/98 7/31/98 2/25/98 2/25/98	Closed Closed Closed Open Closed Closed
11 12 # 1 2 3 4	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K) Consider making all test at three different temperatures (70 K, 80 K and 90 K) perhaps on representative unit	Ehrensberger Chun Assignee Ehrensberger Goebel Goebel Ehrensberger	2/5/98 2/5/98 2/25/98 2/25/98 2/25/98 2/25/98	Closed Closed Closed Open Closed Closed
11 12 # 1 2 3 4 5	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K) Consider making all test at three different temperatures (70 K, 80 K and 90 K) perhaps on representative unit Add the continuity check to P0151 to include EMI shield	Ehrensberger Assignee Ehrensberger Ehrensberger Goebel Ehrensberger Sullivan	2/5/98 2/5/98 2/25/98 2/25/98 2/25/98 2/25/98 2/25/98 2/11/98	Closed Closed Closed Open Closed Closed Closed
11 12 # 1 2 3 4 5 6	Review additional documents needed for TRK package Prepare PCB package for DPA requirement and verification change DPA TRR Action Items (2/6/98) Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc. Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K) Consider making all test at three different temperatures (70 K, 80 K and 90 K) perhaps on representative unit Add the continuity check to P0151 to include EMI shield Release P0357 before the test starts	Ehrensberger Assignee Ehrensberger Goebel Ehrensberger Sullivan Demroff	2/5/98 2/5/98 2/25/98 2/25/98 2/25/98 2/25/98 2/25/98 2/11/98 2/11/98	Closed Closed Closed Open Closed Closed Closed
$ \begin{array}{c} 11 \\ 12 \\ $	Review additional documents needed for TRK packagePrepare PCB package for DPA requirement and verification changeDPA TRR Action Items (2/6/98)Get a list of factors contributing bias requirements, i.e. - power ripple - platform temperature variation etc.Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testing Revise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K)Consider making all test at three different temperatures (70 K, 80 K and 90 K) perhaps on representative unitAdd the continuity check to P0151 to include EMI shield Release P0392 before the test startsRelease P0392 before the test starts	Ehrensberger Assignee Ehrensberger Ehrensberger Goebel Ehrensberger Sullivan Demroff Goebel	2/5/98 2/5/98 2/25/98 2/25/98 2/25/98 2/25/98 2/11/98 2/11/98 2/25/98	Closed Closed Closed Open Closed Closed Closed Closed
11 12 # 1 2 3 4 5 6 7 8	Review additional documents needed for TRK packagePrepare PCB package for DPA requirement and verification changeDPA TRR Action Items (2/6/98)Get a list of factors contributing bias requirements, i.e power ripple- platform temperature variation etc.Get vibration environment from Gayload, Ken Shaul and prepare a plan for vibration testingRevise P0392 to explicitly identify test temperature during the duration of the testing (80+/- 10 K)Consider making all test at three different temperatures (70 K, 80 K and 90 K) perhaps on representative unitAdd the continuity check to P0151 to include EMI shieldRelease P0392 before the test startsRelease P0392 before the test startsSupply calibration data and complete calibration before testing	Ehrensberger Assignee Ehrensberger Ehrensberger Goebel Ehrensberger Sullivan Demroff Goebel B Taller	2/5/98 2/5/98 2/25/98 2/25/98 2/25/98 2/25/98 2/11/98 2/25/98 2/25/98	Closed Closed Closed Open Closed Closed Closed Closed Closed

>All the action items except the number two need to be closed before the testing.